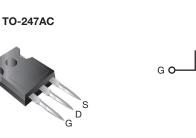


RoHS

COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	900			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 1.6			
Q <sub>g</sub> (Max.) (nC)	200			
Q <sub>gs</sub> (nC)	24			
Q <sub>gd</sub> (nC)	110			
Configuration	Sin	igle		



### S N-Channel MOSFET

#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPF50PbF
	SiHFPF50-E3
SnPb	IRFPF50
	SiHFPF50

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	900	V
Gate-Source Voltage			V <sub>GS</sub>	± 20	v
Continuous Drain Current $V_{GS}$ at 10 V $T_C = 25 \ ^{\circ}C$ $T_C = 100 \ ^{\circ}C$				6.7	
			ID	4.2	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	27	
Linear Derating Factor				1.5	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	880	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	6.7	A
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	19	mJ
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	190	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	1.5	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	
Manatha Tana		12 001014		10	lbf ⋅ in
Mounting Torque	6-32 or M3 screw			1.1	N · m

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 37 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 6.7$  A (see fig. 12).

c.  $I_{SD} \leq 6.7$  A, dl/dt  $\leq 130$  A/µs,  $V_{DD} \leq 600$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.65		

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		·					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	900	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference t	to 25 °C, I <sub>D</sub> = 1 mA	-	1.2	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
Zava Cata Valtaga Duain Cuurant		V <sub>DS</sub> = 9	00 V, V <sub>GS</sub> = 0 V	-	-	100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 720 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	$I_D = 4.0 \ A^b$	-	-	1.6	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 10	00 V, I <sub>D</sub> = 4.0 A <sup>b</sup>	4.9	-	-	S
Dynamic		·					
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V.$		-	2900	-	
Output Capacitance	Coss	V	<sub>DS</sub> = 25 V,	-	270	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0	MHz, see fig. 5	-	92	-	
Total Gate Charge	Qg			-	-	200	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 6.7 A, V <sub>DS</sub> = 360 V, see fig. 6 and 13 <sup>b</sup>	-	-	24	nC
Gate-Drain Charge	Q <sub>gd</sub>	]		-	-	110	
Turn-On Delay Time	t <sub>d(on)</sub>			-	20	-	
Rise Time	t <sub>r</sub>	Vpp - 45	50 V, I <sub>D</sub> = 6.7 A ,	-	34	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			130	-	ns	
Fall Time	t <sub>f</sub>	]		-	37	-	1
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") fro		-	5.0	-	
Internal Source Inductance	L <sub>S</sub>	package and ce die contact	nter of	-	13	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbo showing the		-	-	6.7	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction die	ode	-	-	27	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, Is	$_{\rm S} = 6.7$ A, $V_{\rm GS} = 0$ V <sup>b</sup>	-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C. I 1	6.7 A, dl/dt = 100 A/µs <sup>b</sup>	-	610	920	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	ij = 20 0, if = 1		-	3.2	4.8	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	-on time is negligible (turn	-on is dor	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

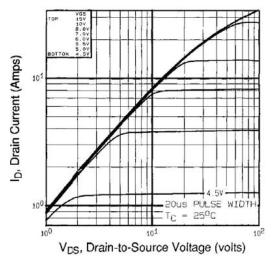
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



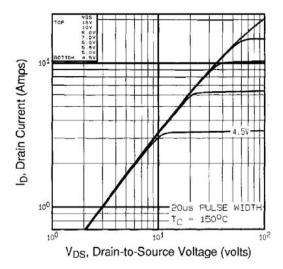
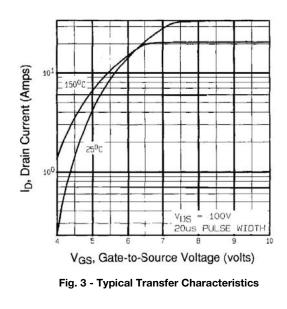


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C



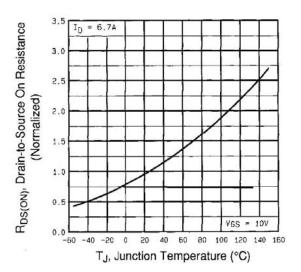


Fig. 4 - Normalized On-Resistance vs. Temperature

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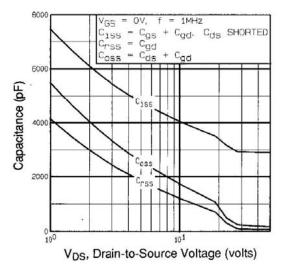


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

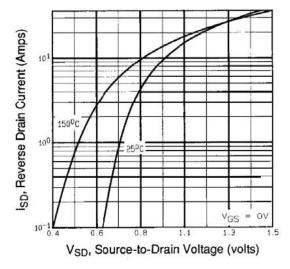


Fig. 7 - Typical Source-Drain Diode Forward Voltage

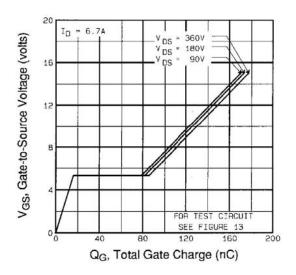


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

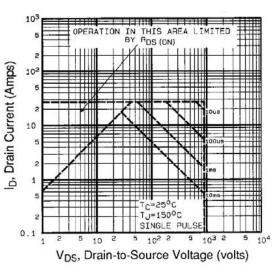


Fig. 8 - Maximum Safe Operating Area



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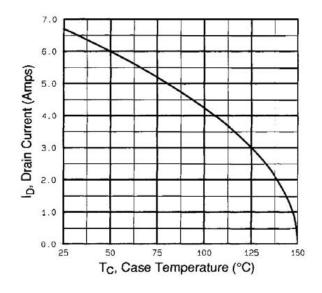


Fig. 9 - Maximum Drain Current vs. Case Temperature

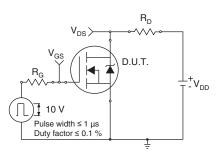


Fig. 10a - Switching Time Test Circuit

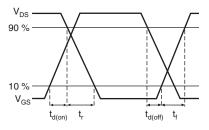


Fig. 10b - Switching Time Waveforms

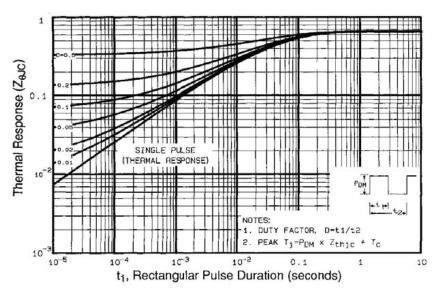


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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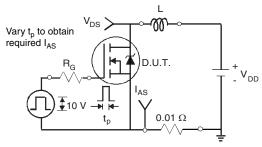


Fig. 12a - Unclamped Inductive Test Circuit

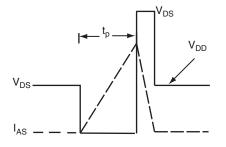


Fig. 12b - Unclamped Inductive Waveforms

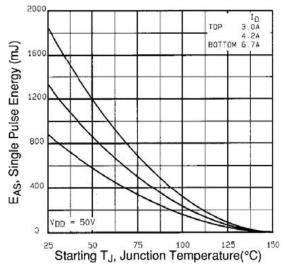


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

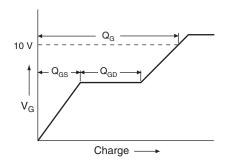
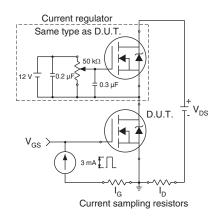
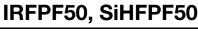


Fig. 13a - Basic Gate Charge Waveform

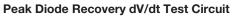


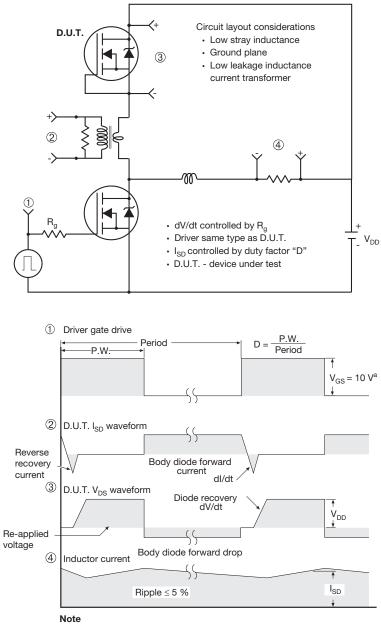


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a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91251</u>.

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## TO-247AC (High Voltage)

### VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN				
DIM.	MIN.	MAX.	NOTES		
D1	16.25	16.85	5		
D2	0.56	0.76			
E	15.50	15.87	4		
E1	13.46	14.16	5		
E2	4.52	5.49	3		
е	5.44	5.44 BSC			
L	14.90	15.40			
L1	3.96	4.16	6		
ØP	3.56	3.65	7		
Ø P1	7.19	7.19 ref.			
Q	5.31	5.69			
S	5.54	5.74			

#### Notes

- <sup>(1)</sup> Package reference: JEDEC<sup>®</sup> TO247, variation AC
- (2) All dimensions are in mm
- <sup>(3)</sup> Slot required, notch may be rounded
- <sup>(4)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(5)</sup> Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



### VERSION 2: FACILITY CODE = Y



MILLIMETERS		MILLIMETERS		MILLI			
DIM.	MIN.	MAX.	NOTES	DIM.	MIN.	MAX.	NOTE
А	4.58	5.31		D2	0.51	1.30	
A1	2.21	2.59		E	15.29	15.87	
A2	1.17	2.49		E1	13.72	-	
b	0.99	1.40		е	5.46	BSC	
b1	0.99	1.35		Øk	0.	254	
b2	1.53	2.39		L	14.20	16.25	
b3	1.65	2.37		L1	3.71	4.29	
b4	2.42	3.43		ØР	3.51	3.66	
b5	2.59	3.38		Ø P1	-	7.39	
С	0.38	0.86		Q	5.31	5.69	
c1	0.38	0.76		R	4.52	5.49	
D	19.71	20.82		S	5.51	BSC	
D1	13.08	-					

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- <sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c



Vishay

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